

PATENT ASSIGNMENT

Electronic Version v1.1
 Stylesheet Version v1.1

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
Dongyoon KIM	09/27/2010
Youngbae PARK	09/27/2010
Sunggi HWANG	09/27/2010
Dongmin KIM	09/27/2010
Seogkyu PARK	09/27/2010
Taehyok KWON	09/27/2010
Taehyeon SIM	09/27/2010
Jongdeuk BAE	09/27/2010
Jaeseok LIM	09/27/2010
Seongno YOON	09/27/2010
Younggon KIM	09/27/2010
Jimaeng KIM	09/27/2010

RECEIVING PARTY DATA

Name:	LG Electronics Inc.
Street Address:	20 Yeouido-dong, Yeongdeungpo-gu
City:	Seoul
State/Country:	REPUBLIC OF KOREA
Postal Code:	150-721

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	12845316

CORRESPONDENCE DATA

Fax Number: (703)205-8050
Correspondence will be sent via US Mail when the fax attempt is unsuccessful.
 Phone: 703-205-8000
 Email: morgans@bskb.com

CH \$40.00 12845316

501350003

PATENT
REEL: 025356 FRAME: 0943

Correspondent Name: Birch, Stewart, Kolasch & Birch, LLP.
Address Line 1: P. O. Box 747
Address Line 4: Falls Church, VIRGINIA 22040-0747

ATTORNEY DOCKET NUMBER:	2832-0505PUS2
--------------------------------	---------------

NAME OF SUBMITTER:	James T. Eller, Jr.
---------------------------	---------------------

Total Attachments: 3 source=20101112assignment#page1.tif source=20101112assignment#page2.tif source=20101112assignment#page3.tif
--

BIRCH, STEWART, KOLASCH & BIRCH, LLP

UNITED STATES PATENT RIGHTS, OR
UNITED STATES PLUS ALL FOREIGN PATENT RIGHTS

ASSIGNMENT

Application No. 12/845,316 Filed July 28, 2010

Insert Name(s)
of Inventor(s)

*****(Given Name FAMILY NAME (ALL CAPS))*****

**WHEREAS, Dongyoon Kim, Youngbae Park, Sunggi Hwang, Dongmin Kim,
Seogkyu Park, Taehyok Kwon, Taehyeon Sim, Jongdeuk Bae,
Jaeseok Lim, Seongno Yoon, Younggon Kim, Jimaeng Kim**
(hereinafter designated as the undersigned) has (have) invented certain new and useful improvements
in:

Insert Title
of Invention

WASHING MACHINE

for which an application for Letters Patent of the United States of America has been executed by the
undersigned (except in the case of a provisional application)

Insert Date
of Signing of
Application

on 9/27/2010; and

Insert Name
of Assignee
Insert Address
of Assignee

WHEREAS, LG Electronics Inc. (Representative: Yong Nam)
of 20 Yeouido-dong, Yeongdeungpo-gu, Seoul, 150-721 Republic of Korea

its heirs, successors, legal representatives and assigns (hereinafter designated as the Assignee) is
desirous of acquiring the entire right, title and interest in and to said invention and in and to any Letters
Patent(s) that may be granted therefor in the United States of America and

CHECK BOX
IF APPROPRIATE

in any foreign countries.

NOW, THEREFORE, in consideration of the sum of Ten Dollars (\$10.00) to the undersigned in hand
paid, the receipt of which is hereby acknowledged, and other good and valuable consideration, the
undersigned has (have) sold, assigned and transferred, and by these presents does sell, assign and
transfer unto said Assignee the full and exclusive right to the said invention in the United States of
America, its territories, dependencies and possessions and the entire right, title and interest in and to
any and all Letters Patent(s) which may be granted therefor in the United States of America, its
territories, dependencies and possessions, and if the box above is designated, in any and all foreign
countries;

and to any and all divisions, reissues, continuations, conversions and extensions thereof for the full
term or terms for which the same may be granted.

The undersigned agree(s) to execute all papers necessary in connection with this application and any continuing, divisional, conversion or reissue applications thereof and also to execute separate assignments in connection with such applications as the Assignee may deem necessary or expedient.

The undersigned agree (s) to execute all papers necessary in connection with any interference which may be declared concerning this application or continuation, division, conversion or reissue thereof or Letter Patent(s) or reissue patent issued thereon and to cooperate with the Assignee in every way possible in obtaining and producing evidence and proceeding with such interference.

The undersigned agree(s) to execute all papers and documents and to perform any act which may be necessary in connection with claims or provisions of the International Convention for the Protection of Industrial Property or similar agreements.


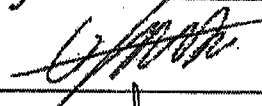
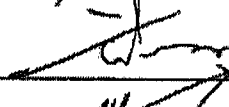


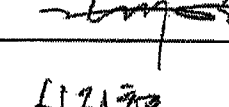
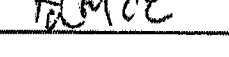
The undersigned agree(s) to perform all affirmative acts which may be necessary to obtain a grant of a valid United States of America patent(s) or a grant of a valid United States of America and any foreign patent(s) to the Assignee and to vest all rights therein hereby conveyed to said Assignee as fully and entirely as the same would have been held by the undersigned if this Assignment and sale had not been made.

The undersigned hereby authorize(s) and request(s) the Patent and Trademark Office Officials in the United States of America and in any foreign countries to issue any and all Letters Patents resulting from said application or any continuing, divisional conversion or reissue applications thereof to the said Assignee, as Assignee of the entire interest, and hereby covenants that he has (they have) the full right to convey the entire interest herein assigned, and that he has (they have) not executed, and will not execute, any agreement in conflict herewith.

The undersigned hereby grant(s) the law firm of Birch, Stewart, Kolasch & Birch, LLP the power to insert on this Assignment any further identification which may be necessary or desirable in order to comply with the rules of the U.S. Patent and Trademark Office for recordation of this document.

The undersigned hereby covenant(s) that no assignment, sale, agreement or encumbrance has been or will be made or entered into which would conflict with this assignment.

In witness whereof, executed by the undersigned on the date(s) opposite the undersigned name(s).

Date <u>09/27/2010</u>	Name of Inventor <u>Dongyoon Kim</u> (signature) 
Date <u>09/27/2010</u>	Name of Inventor <u>Youngbae Park</u> (signature) 
Date <u>09/27/2010</u>	Name of Inventor <u>Sunggi Hwang</u> (signature) 
Date <u>09/27/2010</u>	Name of Inventor <u>Dongmin Kim</u> (signature) 
Date <u>09/27/2010</u>	Name of Inventor <u>Seogkyu Park</u> (signature) 
Date <u>09/27/2010</u>	Name of Inventor <u>Taehyok Kwon</u> (signature) 
Date <u>09/27/2010</u>	Name of Inventor <u>Taehyeon Sim</u> (signature) 

Date	<u>Sep. 27, 2010</u>	Name of Inventor	<u>Jongdeuk Bae</u> (signature)
Date	<u>Sep. 27, 2010</u>	Name of Inventor	<u>Jaeseok Lim</u> (signature)
Date	<u>Sep. 27, 2010</u>	Name of Inventor	<u>Seongno Yoon</u> (signature)
Date	<u>Sep. 27, 2010</u>	Name of Inventor	<u>Younggon Kim</u> (signature)
Date	<u>Sep. 27, 2010</u>	Name of Inventor	<u>Jimaeng Kim</u> (signature)